

**INFRA RED (IR) BASED TOMOGRAPHY SYSTEM:  
A COMPARISON BETWEEN ORTHOGONAL AND FAN BEAM PROJECTION**

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A COMPARISON BETWEEN ORTHOGONAL AND FAN  
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Dedicated for my beloved father and mother...

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## ABSTRACT

This project is to design, implement and compare infra red based tomography system which using orthogonal and fan beam projection. Here, the basic concept of orthogonal and fan beam projection must be understood. Infra red will be used as the light emitter and receiver sensor in this project. In terms of hardware, two types of jig/fixture will be designed in order to comparing orthogonal and fan beam projection. The reconstructed images from these two types of projections (orthogonal and fan beam) can be formed by design a signal conditional circuit and fabricate into printed circuit board (PCB) and the data from this circuit will be transferred through Data Acquisition (DAQ). Besides the hardware, this project will include the use of user friendly, Visual Basic 6.0 program to implement voltage linear back projection in order to reconstruct the image by comparing the result between both projections. Through this project, the comparison result of both projections can be obtained.

## ABSTRAK

Projek ini adalah untuk mereka bentuk, melaksanakan dan membandingkan inframerah berdasarkan sistem tomografi (kaedah radiografi yang mempamerkan perincian tubuh badan) dengan menggunakan unjuran  $90^\circ$  dan unjuran sinaran kipas. Di sini, konsep asas unjuran  $90^\circ$  dan unjuran sinaran kipas haruslah difahami. Inframerah akan digunakan sebagai cahaya pemancar dan penerima penderia dalam projek ini. Dari segi perkakasan, 2 jenis aci (alat pemegang sesuatu bahan kerja supaya ia tetap) akan direka untuk membandingkan unjuran  $90^\circ$  dan unjuran sinaran kipas. Pembinaan semula imej daripada 2 jenis unjuran ini (unjuran  $90^\circ$  dan unjuran sinaran kipas) akan dibentuk dengan merekabentuk satu litar isyarat dan dibina ke dalam litar tercetak dan data daripada litar ini akan dipindahkan ke dalam sistem perolehan data. Selain daripada perkakasan, projek ini termasuk dengan penggunaan pengguna yang mesra, program visual asas 6.0 untuk melaksanakan unjuran voltan garis lurus belakang dalam pembinaan semula imej dengan membandingkan keputusan di antara 2 jenis unjuran tersebut. Melalui projek ini, keputusan perbandingan di antara 2 jenis unjuran tersebut akan diperoleh.



## TABLE OF CONTENTS

<b>CHAPTER</b>	<b>CONTENTS</b>	<b>PAGE</b>
	<b>TITLE</b>	i
	<b>STATUS REPORT FORM</b>	ii
	<b>VERIFICATION OF REPORT</b>	iii
	<b>VERIFICATION BY SUPERVISOR</b>	iv
	<b>DEDICATION</b>	v
	<b>ACKNOWLEDGEMENTS</b>	vi
	<b>ABSTRACT</b>	vii
	<b>ABSTRAK</b>	viii
	<b>TABLE OF CONTENTS</b>	ix
	<b>LIST OF TABLES</b>	xiii
	<b>LIST OF FIGURES</b>	xiv
	<b>LIST OF APPENDICES</b>	xvii
<b>I</b>	<b>INTRODUCTION</b>	
	1.1 Project Synopsis	1
	1.2 Project Objectives	1
	1.3 Problem Statements	2
	1.4 Scopes Of Work	2
	1.5 Expected Result	3
<b>II</b>	<b>LITERATURE REVIEW</b>	

2.1	Process Tomography	4
2.2	Types Of Projection	6
2.3	Types Of Sensor	11
2.3.1	Electrical Capacitance Tomography	12
2.3.2	Ultrasonic Tomography	13
2.3.3	Gamma Ray Tomography	15
2.3.4	Optical Tomography	16
2.4	Data Acquisition (DAQ)	17
2.4.1	Quantizing Theory	20
2.4.2	Analog-To-Digital Conversion	21
	2.4.2.1 Introduction	21
	2.4.2.2 Analog-to-Digital Converters	24
2.4.3	Digital-To-Analog Conversion	28

### **III METHODOLOGY**

3.1	A Comparison Between Orthogonal And Fan Beam Projections	32
3.1.1	Fan Beam Projection Technique	32
3.1.2	Parallel Projection Technique (Orthogonal Projection)	34
3.2	Hardware	35
3.2.1	Infrared Sensor	36
3.2.2	Infrared Receiving Circuit	36
3.2.3	Data Acquisition (DAQ)	39
3.2.4	Image Reconstruction	40
3.2.5	Linear Back Projection (LBP) Algorithm	40
3.3	Software	52

**IV RESULTS & DISCUSSION**

4.1	Introduction	55
4.2	Prototype Circuit (Receiving Circuit)	55
4.3	Pipe Design	59
4.3.1	Jig/fixture of the projection	60
4.4	Experiment To Evaluate IR Penetration Limit	61
4.5	Result Of Image Reconstruction For Orthogonal Projection	64
4.5.1	Result for 2cm x 2cm	65
4.5.2	Result for 3cm x 3cm	66
4.5.3	Result for 4cm x 4cm	68
4.6	Result Of Image Reconstruction For Fan Beam Projection	71
4.6.1	Result for 2cm x 2cm	72
4.6.2	Result for 3cm x 3cm	73
4.6.3	Result for 4cm x 4cm	74
4.7	Color Scheme	76

**V CONCLUSION & SUGGESTION**

5.1	Conclusion	77
5.2	Future Recommendation	78

<b>REFERENCES</b>	<b>79</b>
-------------------	-----------

<b>APPENDIX A</b>	80
<b>APPENDIX B</b>	85
<b>APPENDIX C</b>	88
<b>APPENDIX D</b>	90
<b>APPENDIX E</b>	103
<b>APPENDIX F</b>	116

**LIST OF TABLES**

<b>NO</b>	<b>TITLE</b>	<b>PAGE</b>
2.1	Sensor Grouping	12
2.2	2-bit flash converter output	27
3.1	Implementation schedule of PSM I	54
3.2	Implementation schedule of PSM II	54

## LIST OF FIGURES

NO	TITLE	PAGE
2.1	X-ray tomographic projection	6
2.2	Parallel beam projections	7
2.3	Two orthogonal projections	8
2.4	Two rectilinear projections	8
2.5	Three rectilinear projections	9
2.6	A combination of two orthogonal and two rectilinear projections	9
2.7	Three fan-beam projections	10
2.8	Four fan-beam projections	10
2.9	Analog signal and sampled equivalent	18
2.10	Aliasing	19
2.11	Analog-to-digital conversions	20
2.12	Components used in A / D conversion	22
2.13	Block diagram of the KUSB-3108	23
2.14	A/D conversion aperture time	24
2.15	Successive approximation A/D converters	25
2.16	4-bit successive approximation A/D conversions	26
2.17	A/D flash converters	27
2.18	4-bit resistor ladder D/A converter	28
2.19	4-bit resistor ladder D/A with digital input 0001	29
2.20	Computer control hardware	31
3.1	Two fan-beam projections	33

3.2	Four fan-beam projections	33
3.3	Parallel beam projections	34
3.4	Two orthogonal projections	35
3.5	Block diagram of developed system	35
3.6	Signal conditioning for receiver circuit	37
3.7	Receiving circuit	39
3.8	Illustration of back projection scheme	41
3.9	The sensitivity map for 16 matrices of projection for orthogonal	45
3.10	The sensitivity map for 16 matrices of projection for fan beam	51
3.11	GUI of the system	52
3.12	Methodology of the project	53
4.1	Prototype circuit (receiving circuit)	56
4.2	Infrared (transmitter)	56
4.3	Taking measurement from the circuit. Range from the transmitter to the receiver sensor is 10 cm.	57
4.4	Output 10 V using oscilloscope	57
4.5	Obstruction at the signal path (between emitter and receiver)	58
4.6	Output when an infrared (emitter) was blocked	58
4.7	The conveyor pipe of orthogonal projection	59
4.8	The conveyor pipe of fan beam projection	59
4.9	Dimension of conveyor pipe	60
4.10	Jig/fixture of orthogonal projection	60
4.11	Jig/fixture of fan beam projection	61
4.12	Types of cube size (4cm, 3cm and 2cm)	62
4.13	Measurement part using orthogonal projection	62
4.14	Measurement part using fan beam projection	63
4.15	Infrared light come out from digital camera (orthogonal projection)	63
4.16	Infrared light come out from digital camera (fan beam projection)	64
4.17	The minimum value at voltage drop in 1 channel	65

4.18	The minimum value at voltage drop in 16 channels	65
4.19	Concentration profile and LBP algorithm interfaced using VB	66
4.20	The minimum value at voltage drop in 1 channel	66
4.21	The minimum value at voltage drop in 16 channels	67
4.22	Close up view of voltage drop at minimum value of measurement	67
4.23	Concentration profile and LBP algorithm interfaced using VB	68
4.24	The minimum value at voltage drop in 1 channel	68
4.25	The minimum value at voltage drop in 16 channels	69
4.26	Close up view of voltage drop at minimum value of measurement	70
4.27	Concentration profile and LBP algorithm interfaced using VB	71
4.28	The minimum value at voltage drop in 1 channel	72
4.29	Concentration profile and LBP algorithm interfaced using VB	72
4.30	The minimum value at voltage drop in 1 channel	73
4.31	Concentration profile and LBP algorithm interfaced using VB	73
4.32	The minimum value at voltage drop in 1 channel	74
4.33	The minimum value at voltage drop in 16 channels	74
4.34	Close up view of voltage drop at minimum value of measurement	75
4.35	Concentration profile and LBP algorithm interfaced using VB	75
4.36	Color scheme bar	76



**LIST OF APPENDICES**

<b>NO</b>	<b>TITLE</b>	<b>PAGE</b>
A	TL084CN Datasheet	80
B	Infrared Led Datasheet	85
C	Layout Of PCB For Receiving Circuit	88
D	Orthogonal Projection Data Sample For Measurement Of Object With Dimension Of 2cmx2cm, 3cmx3cm And 4cmx4cm	90
E	Fan Beam Projection Data Sample For Measurement Of Object With Dimension Of 2cmx2cm, 3cmx3cm And 4cmx4cm	103
F	Source Code Of Programming	116

## **CHAPTER 1**

### **INTRODUCTION**

#### **1.1 Project Synopsis**

The objective of this project is to design, implement and compare infra red based tomography system which using orthogonal and fan beam projection. Infra red will be used as the light emitter and receiver sensor in this project. The reconstructed images from these two types of projections can be formed by reconstructing signal control circuit, jig and fixture design / fabrication. Besides the hardware, this project will include the use of user friendly, Visual Basic 6.0 program to visualize the concentration profile by comparing the result between both projections.

#### **1.2 Project Objectives**

1. To design jig/fixture for IR based tomography system using orthogonal and fan beam projection.
2. To design and fabricate PCB of signal conditional circuit.
3. To compare IR based tomography system using orthogonal and fan beam projection.

4. To interface hardware circuit using Visual Basic through Data Acquisition (DAQ).
5. To design a program that can visualize the concentration profile by comparing the result between both projections using Visual Basic 6.0.

### **1.3 Problem Statements**

Process tomography is the method to obtain cross-sectional image over measurement area. There are several methods to array the projection such as:

1. Orthogonal projection.
2. Fan beam projection.
3. Rectilinear projection.
4. Mix all projection.

Most of the researches in process tomography are related on orthogonal projections because it is easy to implement. However, compare to the orthogonal projection, the fan beam projection will give high resolution image, although it used the same number of sensor.

### **1.4 Scopes Of Work**

The scopes of work for this project including:

1. To understand the concept of orthogonal and fan beam projection.
2. To design, fabricate or build signal conditional circuit.
3. To test the usability of IR sensor for this project.
4. To design, evaluate and manufacture jig/fixture that can produce 2 types of projections (orthogonal and fan beam).
5. To implement voltage linear back projection in order to reconstruct the image using Visual Basic.

### **1.5 Expected Result**

The expected result that student should get from this project is to develop or built several hardware which can compare the infra red based tomography system which using orthogonal and fan beam projection. The images from these two types of projections can be formed by reconstructing signal obtained from signal control circuit, and be process with software (Visual Basic 6.0) to visualize the concentration profile by comparing the result between two projections. Through this project, the comparison result of both projections can be obtained.

## CHAPTER 2

### LITERATURE RIVIEW

#### 2.1 Process Tomography

*Tomography* refers to the reconstruction of the internal distribution of 2D and 3D objects from multiple external viewpoints, thus providing cross-sectional slices through the object. The term originates from the Greek words *tomos* (for slice) and *graph* (for image). The term is commonly found in medical diagnostics, where computerized tomography (CT) x-ray scanning systems are well known. The medical applications of tomography provide a useful illustration of the principle, although this review is of course concerned primarily with industrial processes.

In a conventional x-ray imaging system, a cone-shaped beam of x-rays is used to illuminate the subject on one side. In passing through the subject, the radiation is attenuated (either absorbed or scattered) in proportion to the local electronic density; thus, variations in density or composition determine the intensity of the radiation as it leaves the subject. The final intensity pattern is captured as an image on a photographic plate mounted on the opposite side. The pixels of the resulting photograph (radiograph) represent the attenuation integrated through the object along the rays emanating from the source. This integration in effect removes depth information from the image, so if for

example a tumor were seen on a radiograph one could not determine (on the basis of one image) which of several overlaying organs was affected.

In contrast, early tomography systems used several different views to build up an image of a slice at a predetermined depth in the subject. Most x-ray tomography systems in recent times have been designed to obtain cross-sectional slice images perpendicular to some axis, around which the sources and detectors are rotated. This process is known as axial tomography. In a first-generation CT system, a narrow x-ray beam is transmitted through the subject, and a collimated detector is placed on the side of the subject. This measures the line-integrated attenuation of the beam through the subject along the path so defined. Figure 2.1 illustrates this arrangement in general form. The example subject has a circular cross-section and contains further contrasting circular features. An x-ray transmission source  $U$  and receiver  $V$  are shown. A beam is transmitted from the source along the line shown, displaced by length  $s$  from the origin and at angle  $\theta$ , creating the line of integration,  $l$ . The measurement system measures the path integral of the subject's density distribution along this line, and it call this quantity the path density integral (PDI). If the angle is held constant and the beam is displaced across the subject (in direction  $s$ ), a “shadow” of the subject can be seen in the attenuation data. This composite set of data is called the *projection*.

A set of projections can be obtained by repeating this process for a range of values of the angle  $\theta$ , in effect providing an observation of the subject's shadow from multiple viewpoints. From an intuitive perspective, these projections are the prerequisite for tomographic imaging. In fact, from a mathematical perspective, the individual PDI values are the basic requirement.

Clearly, the measured PDI values will depend on the attenuation distribution, depicted in Figure 2.1 as  $f(x, y)$ . If sufficient PDI data are obtained, these may be used to estimate this distribution. In mathematical terms, this is a classic inverse problem, and the process of solving it to generate the estimated distribution is commonly called *image*

*reconstruction*. The quality of the resulting estimate depends on the quality and number of PDI data and on the reconstruction algorithm.

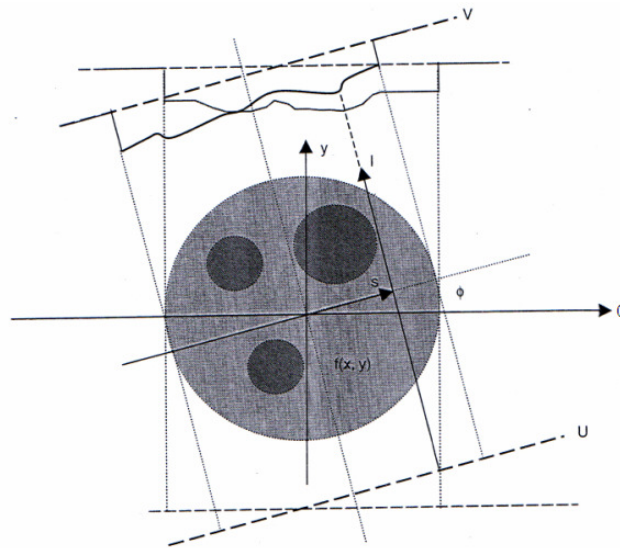


Figure 2.1 X-ray tomographic projection

## 2.2 Types Of Projection

Tomographic techniques vary widely in their instrumentation and applications, all of them can be characterized by a common two-step approach to the imaging process; firstly gather projection data based on some physical sensing mechanism, then reconstruct a cross sectional image from the projections. The term “projection” has a specific meaning in tomography which a projection can be visualized as type of radiography of the process vessel.

In tomography, many projections are needed to reconstruct the interior volume or cross-section of an object. Projections actually can be referred as sensor arrangement. In practical systems, there are two types of projection that have been investigated and applied to measure gas / solid flow, which are:

1. Parallel projection (Orthogonal Projection).
2. Fan beam projection

For parallel projection, the number of emitter and receiver are the same. Each pair of trans-receiver is arranged in a straight line and the received signal only corresponds to its emitter source, while for fan beam projection, the number of emitter and receivers can be unequal. The fan beam projection technique provides a higher resolution system compared to the same number of sensors used in parallel projection due to high obtaining information several projections are needed to reduce aliasing which occurs when two particles intercept the same view.

However from both methods, it can be illustrated into a various techniques of arrangement which all of that has been widely investigated to implement into flow imaging of conveying system. The various arrangements can be illustrated into six types of projection, which are:

1. Parallel beam projection. (Figure 2.2)
2. Two orthogonal projections. (Figure 2.3)
3. Two rectilinear projections. (Figure 2.4)
4. Three rectilinear projections. (Figure 2.5)
5. A combination of two orthogonal and two rectilinear projections. (Figure 2.6)
6. Three fan-beam projections. (Figure 2.7)
7. Four fan-beam projections. (Figure 2.8)

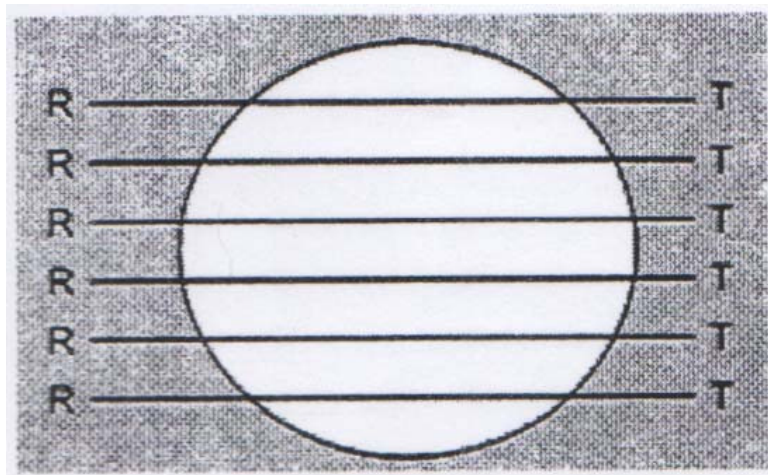


Figure 2.2 Parallel beam projections